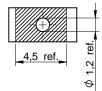
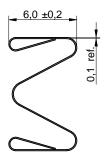
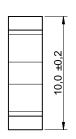
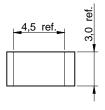
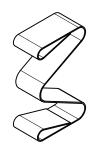
Dimensions: [mm]



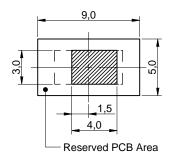








Recommended Land Pattern: [mm]



Scale - 3:1

CREATED

KaS

Properties:

Material	Copper Beryllium (CuBe) gold-plated(AU)
Recommended Working Height	8.3 mm - 9.7 mm

General Information:

Storage Temperature (in original packaging)	-40 °C up to +100 °C					
Operating Temperature	-40 °C up to +100 °C					
Test conditions of Electrical Properties: +20°C, 33% RH if not specified differently						

Würth Elektronik eiSos GmbH & Co. KG EMC & Inductive Solutions

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Scale - 3:1

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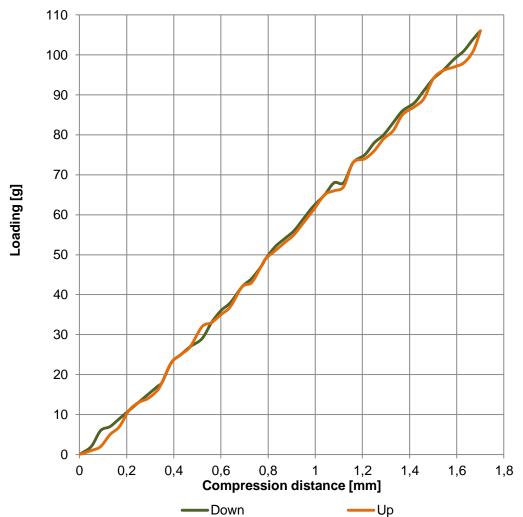
CHECKED GENERAL TOLERANCE
JOV DIN ISO 2768-1m

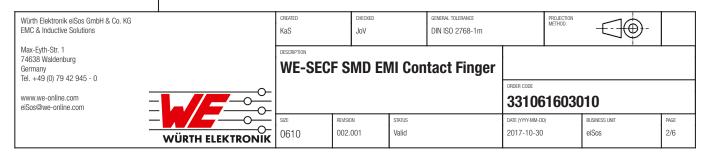
eneral tolerance IN ISO 2768-1m

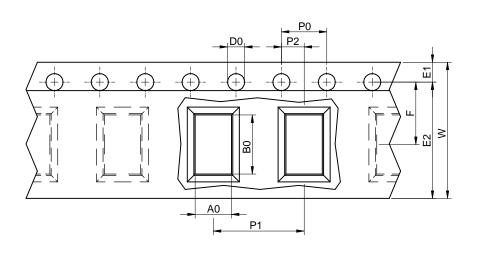
WE-SECF SMD EMI Contact Finger

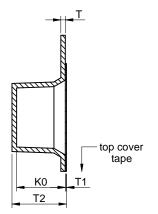
331061603010

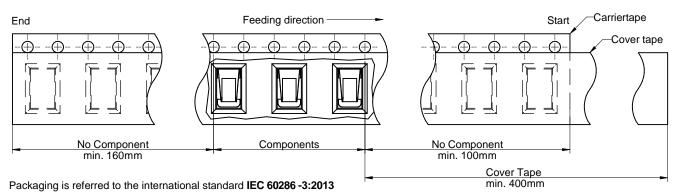
Force Deflection Diagram:



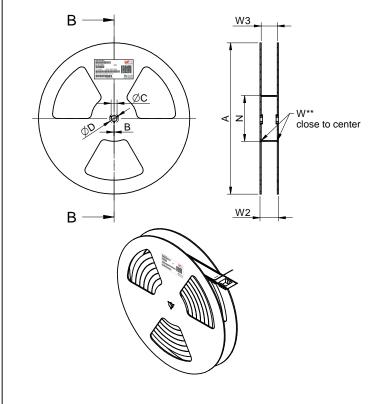




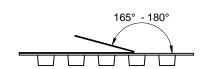




		A0	B0	W	P1	T	T1	T2	D0	E1	E2	F	P0	P2	Tape	VPE / packaging unit
tolerance		typ.	typ.	±0,3	±0,1	±0,1	max.	typ.	+0,1/-0.0	±0,1	min.	±0,05	±0,1	±0,05		pcs.
size	0610	3.20	6.2	16	12	0.5	0.1	10.7	1.5	1.75	14.25	7.5	4	2	Polystyrene	500



		Α	В	C	D	N	W1	W2	W3	W3
tolerance		±- 2,0			m- in.		+1.5	max.	m- in.	max.
Tape width	16 mm	330	1- .5	13	2- 0.2	1- 00		22 40	1- 5.9	19.3999999999999



 Pull-of force

 Tape width
 16 mm
 0,1 N - 1,3 N

Würth Elektronik eiSos GmbH & Co. KG
EMC & Inductive Solutions

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Wirth Elektronik

CREATED CHECKED GENERAL TOLERANCE DIN ISO 2768-1m

DESCRIPTION

DESCRIPTION

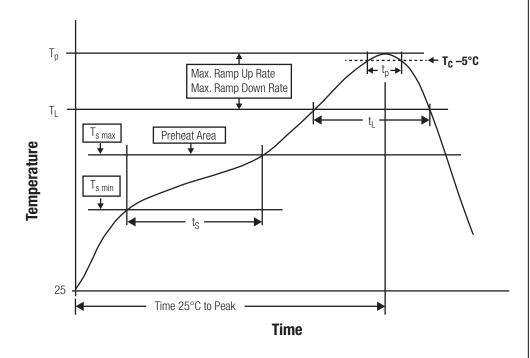
DESCRIPTION

WE-SECF SMD EMI Contact Finger

331061603010

REVISION STATUS DATE (YYYY-MM-DD) BUSINESS UNIT PAGE 002.001 Valid 2017-10-30 eiSos 3/6

Classification Reflow Profile for SMT components:



Classification Reflow Soldering Profile:

D (1 E 1		
Profile Feature		Value
Preheat Temperature Min	T _{s min}	150 °C
Preheat Temperature Max	T _{s max}	200 °C
Preheat Time t_s from $T_{s min}$ to $T_{s max}$	t _s	60 - 120 seconds
Ramp-up Rate (T _L to T _P)		3 °C/ second max.
Liquidous Temperature	T_{L}	217 °C
Time t _L maintained above T _L	t _L	60 - 150 seconds
Peak package body temperature	T_p	see table below
Time within 5°C of actual peak temperaure	t p	20 - 30 seconds
Ramp-down Rate (T _L to T _P)		6 °C/ second max.
Time 25°C to peak temperature		8 minutes max.

refer to IPC/ JEDEC J-STD-020E

Package Classification Reflow Temperature:

Properties	Volume mm³ <350	Volume mm ³ 350-2000	Volume mm³ >2000
PB-Free Assembly Package Thickness < 1.6 mm	260 °C	260 °C	260 °C
PB-Free Assembly Package Thickness 1.6 mm - 2.5 mm	260 °C	250 °C	245 °C
PB-Free Assembly I Package Thickness ≥ 2.5 mm	250 °C	245 °C	245 °C

refer to IPC/ JEDEC J-STD-020E

Würth Elektronik eiSos GmbH & Co. KG EMC & Inductive Solutions		created KaS	JoV		GENERAL TOLERANCE DIN ISO 2768-1m		PROJECTION METHOD		
Max-Eyth-Str. 1 74638 Waldenburg Germany Tel. +49 (0) 79 42 945 - 0		DESCRIPTION WE-SEC	F SMD EN	/II Con	tact Finger			'	
www.we-online.com eiSos@we-online.com	<u></u>					ORDER CODE 33106	16030)10	
	WÜRTH ELEKTRONIK	0610	002.001	status Valid		DATE (YYYY-MM-DE 2017-10-30	*	BUSINESS UNIT eiSos	PAGE 4/6

Cautions and Warnings:

The following conditions apply to all goods within the product series of WE-SECF of Würth Elektronik eiSos GmbH & Co. KG:

General:

All recommendations according to the general technical specifications of the data sheet have to be complied with.

The responsibility for the applicability of customer specific products and use in a particular customer design is always within the authority of the customer. All technical specifications for standard products do also apply to customer specific products.

Product specific:

Follow all instructions mentioned in the data sheet, especially:

- The soldering profile has to be complied with according to the technical reflow soldering specification, otherwise this will void the
 warranty.
- To avoid contact finger misplacement and the coming off the soldering joints use maximum adjusted force at the Pick- and Place
 machine that does not exceed the recommended compression rate (of the contact fingers).
- The soldering joints must be kept clean, dry and grease free. The contact finger should be placed onto the solder pad of the printed circuit board in a way that no tin- solder is able to come into the undermost or the first elastic bending of the contact fingers so that the bendingwill not be affected.
- The contact finger shall not exceed the recommended compression rate. If recommended compression rate is exceeded there is a risk that the spring will not be able to push back into the initial state.
- Do not bend the contact finger into the opposite position, as the material will overstretch and possibly break.
- Violation of the technical product specifications will void the warranty.

The general and prodcut specific cautions comply with the state of the scientific and technical knowledge and are believed to be accurate and reliable; however, no responsibility is assumed for inaccuracies or incompleteness.

Würth Elektronik eiSos GmbH & Co. KG EMC & Inductive Solutions		CREATED KaS	JoV		GENERAL TOLERANCE DIN ISO 2768-1m		PROJECTION METHOD		
Max-Eyth-Str. 1 74638 Waldenburg Germany Tel. +49 (0) 79 42 945 - 0		WE-SEC	F SMD EI	MI Con	tact Finger				
www.we-online.com eiSos@we-online.com			_		331061603010				
	WÜRTH ELEKTRONIK	0610	002.001	status Valid		DATE (YYYY-MM-DI 2017-10-30		BUSINESS UNIT eiSos	PAGE 5/6

Important Notes

The following conditions apply to all goods within the product range of Würth Elektronik eiSos GmbH & Co. KG:

1. General Customer Responsibility

Some goods within the product range of Würth Elektronik eiSos GmbH & Co. KG contain statements regarding general suitability for certain application areas. These statements about suitability are based on our knowledge and experience of typical requirements concerning the areas, serve as general guidance and cannot be estimated as binding statements about the suitability for a customer application. The responsibility for the applicability and use in a particular customer design is always solely within the authority of the customer. Due to this fact it is up to the customer to evaluate, where appropriate to investigate and decide whether the device with the specific product characteristics described in the product specification is valid and suitable for the respective customer application or not.

2. Customer Responsibility related to Specific, in particular Safety-Relevant Applications

It has to be clearly pointed out that the possibility of a malfunction of electronic components or failure before the end of the usual lifetime cannot be completely eliminated in the current state of the art, even if the products are operated within the range of the specifications. In certain customer applications requiring a very high level of safety and especially in customer applications in which the malfunction or failure of an electronic component could endanger human life or health it must be ensured by most advanced technological aid of suitable design of the customer application that no injury or damage is caused to third parties in the event of malfunction or failure of an electronic component. Therefore, customer is cautioned to verify that data sheets are current before placing orders. The current data sheets can be downloaded at www.we-online.com.

3. Best Care and Attention

Any product-specific notes, cautions and warnings must be strictly observed. Any disregard will result in the loss of warranty.

4. Customer Support for Product Specifications

Some products within the product range may contain substances which are subject to restrictions in certain jurisdictions in order to serve specific technical requirements. Necessary information is available on request. In this case the field sales engineer or the internal sales person in charge should be contacted who will be happy to support in this matter.

5. Product R&D

Due to constant product improvement product specifications may change from time to time. As a standard reporting procedure of the Product Change Notification (PCN) according to the JEDEC-Standard inform about minor and major changes. In case of further queries regarding the PCN, the field sales engineer or the internal sales person in charge should be contacted. The basic responsibility of the customer as per Section 1 and 2 remains unaffected.

6. Product Life Cycle

Due to technical progress and economical evaluation we also reserve the right to discontinue production and delivery of products. As a standard reporting procedure of the Product Termination Notification (PTN) according to the JEDEC-Standard we will inform at an early stage about inevitable product discontinuance. According to this we cannot guarantee that all products within our product range will always be available. Therefore it needs to be verified with the field sales engineer or the internal sales person in charge about the current product availability expectancy before or when the product for application design-in disposal is considered. The approach named above does not apply in the case of individual agreements deviating from the foregoing for customer-specific products.

7. Property Rights

All the rights for contractual products produced by Würth Elektronik eiSos GmbH & Co. KG on the basis of ideas, development contracts as well as models or templates that are subject to copyright, patent or commercial protection supplied to the customer will remain with Würth Elektronik eiSos GmbH & Co. KG does not warrant or represent that any license, either expressed or implied, is granted under any patent right, copyright, mask work right, or other intellectual property right relating to any combination, application, or process in which Würth Elektronik eiSos GmbH & Co. KG components or services are used.

8. General Terms and Conditions

Unless otherwise agreed in individual contracts, all orders are subject to the current version of the "General Terms and Conditions of Würth Elektronik eiSos Group", last version available at www.we-online.com.

